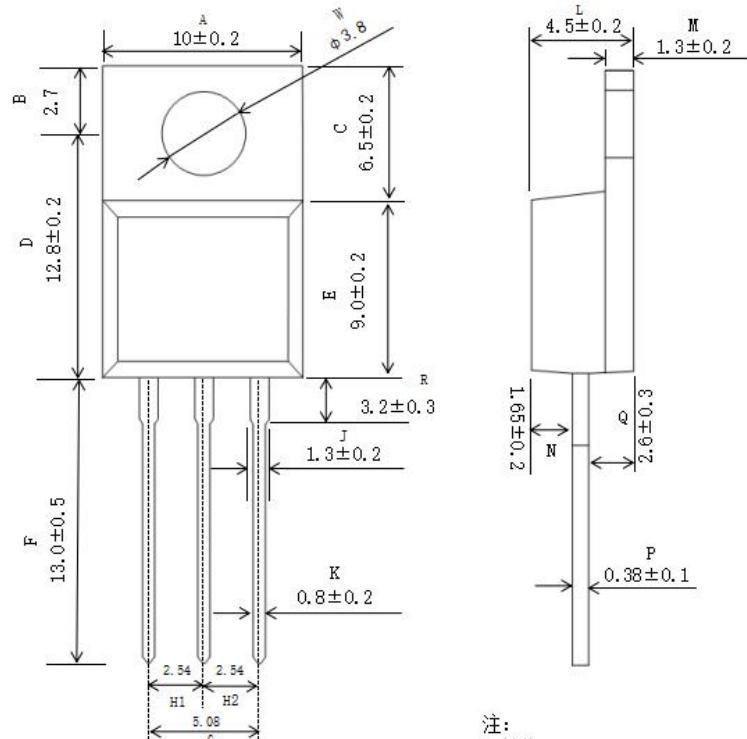
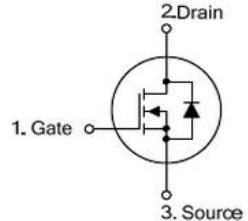


**◆ Features:**

- ◆ Fast switching speed  
开关速度快
- ◆ Low gate charge  
低门充電
- ◆ High power and current handing capability  
高功率和电流处理能力
- ◆ RoHS compliant  
符合 RoHS 标准

**◆ Applications**

- ◆ DC to DC converters  
直流到直流转换
- ◆ Synchronous Rectification  
同步整流

**TO-220AB**

注：  
1. 单位：mm  
2. 未注公差：±0.2mm  
(除非另有说明)



OSP80N03T

<http://www.osen.net.cn>

LOW Voltage Trench Nch MOSFET

## ◆ Absolute Maximum Ratings (Tc=25°C)

Symbol	Parameters	Ratings		Unit
V <sub>DSS</sub>	Drain-Source Voltage 漏源电压	30		V
V <sub>GS</sub>	Gate-Source Voltage-Continuous 栅源电压	±20		V
I <sub>D</sub>	Drain Current-Continuous (Note 2) 漏极持续电流	80		A
I <sub>DM</sub>	Drain Current-Single Plused (Note 1) 漏极单次脉冲电流	320		A
P <sub>D</sub>	Power Dissipation (Note 2) 功率损耗	110		W
T <sub>j</sub>	Max.Operating junction temperature 最大结温	150		°C

## ◆ Electrical characteristics (Tc=25°C unless otherwise noted)

Symbol	Parameters	Min	Typ	Max	Units	Conditions
<b>Static Characteristics</b>						
B <sub>VDSS</sub>	Drain-Source Breakdown VoltageCurrent (Note 1) 漏极击穿电压	30	--	--	V	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V
V <sub>GS(th)</sub>	Gate Threshold Voltage 栅极开启电压	1.0	1.5	2.5	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA
R <sub>DS(on)</sub>	Drain-Source On-Resistance 漏源导通电阻	--	4.3	5.5	mΩ	V <sub>GS</sub> =10V, I <sub>D</sub> =20A
I <sub>GSS</sub>	Gate-Body Leakage Current 栅极漏电流	--	--	±100	nA	V <sub>GS</sub> =±25V, V <sub>DS</sub> =0
I <sub>DSS</sub>	Zero Gate Voltage Drain Current 零栅极电压漏极电流	--	--	1	μA	V <sub>DS</sub> =30V, V <sub>GS</sub> =0
g <sub>fS</sub>	Forward Transconductance 正向跨导	20	--	--	S	V <sub>DS</sub> =10V, I <sub>D</sub> =20A



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Switching Characteristics						
T <sub>d(on)</sub>	Turn-On Delay Time 开启延迟时间	--	<b>15</b>	--	ns	V <sub>GS</sub> =10V, V <sub>DS</sub> =30V,I <sub>D</sub> =30A, R <sub>G</sub> =1Ω
T <sub>r</sub>	Rise Time 上升时间	--	<b>13</b>	--	ns	
T <sub>d(off)</sub>	Turn-Off Delay Time 关闭延迟时间	--	<b>35</b>	--	ns	
T <sub>f</sub>	Fall Time 下降时间	--	<b>10</b>	--	ns	
Q <sub>g</sub>	Total Gate Charge 栅极总电荷	--	<b>75</b>	--	nC	
Q <sub>gs</sub>	Gate-Source Charge 栅源极电荷	--	<b>15</b>	--	nC	
Q <sub>gd</sub>	Gate-Drain Charge 栅漏极电荷	--	<b>25</b>	--	nC	
Dynamic Characteristics						
C <sub>iss</sub>	Input Capacitance 输入电容	--	<b>2250</b>	--	pF	V <sub>DS</sub> =20V, V <sub>GS</sub> =0, f=1MHz
C <sub>oss</sub>	Output Capacitance 输出电容	--	<b>365</b>	--	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance 反向传输电容	--	<b>55</b>	--	pF	
I <sub>S</sub>	Continuous Drain-Source Diode Forward Current (Note 2) 二极管导通正向持续电流	--	--	<b>80</b>	A	
V <sub>SD</sub>	Diode Forward On-Voltage 二极管正向导通电压	--	--	<b>0.7</b>	V	I <sub>S</sub> =1A, V <sub>GS</sub> =0
R <sub>th(j-c)</sub>	Thermal Resistance, Junction to Case 结到外壳的热阻	--	--	<b>1.13</b>	°C/W	

Note 1: Repetitive Rating : Pulse width limited by maximum junction temperature

Note 2: Pulse test: PW <= 300us , duty cycle <= 2%.